

Electronic Supplementary Information

Self-Powered Flexible Sensing System Based on Super-Tough, High Ionic Conductivity and Rapid Self-Recovery Fully Physically Crosslinked Double Network Hydrogel

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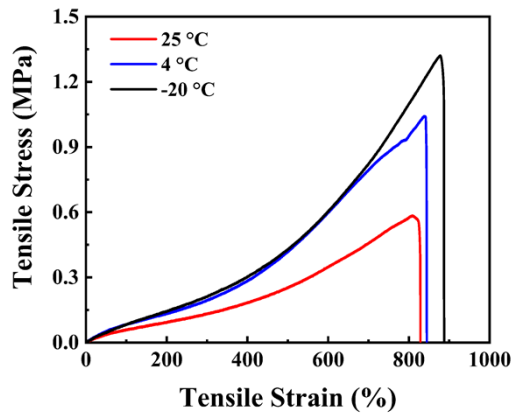


Fig. S1 Stress-strain curves of P₈N₆H₃₀ DN hydrogels prepared by UV light polymerization after refrigerated at -20 °C, 4 °C, 25 °C for 2 h.

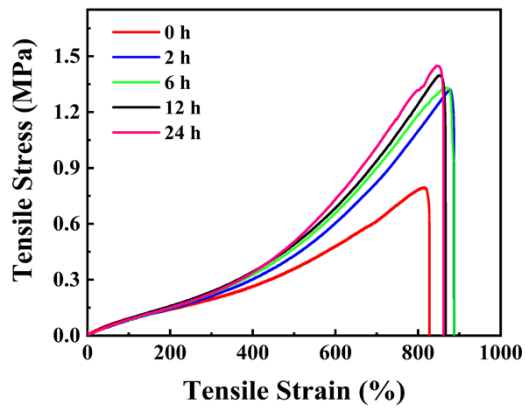


Fig. S2 Stress-strain curves of P₈N₆H₃₀ DN hydrogels prepared by UV light polymerization after refrigerated at -20 °C for 0, 2, 6, 12 and 24 h.

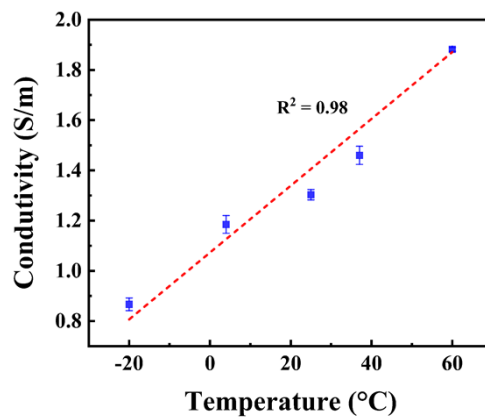


Fig. S3 Conductivity of the PNH DN hydrogel at -20 °C, 4 °C, 25 °C, 37 °C and 60 °C.

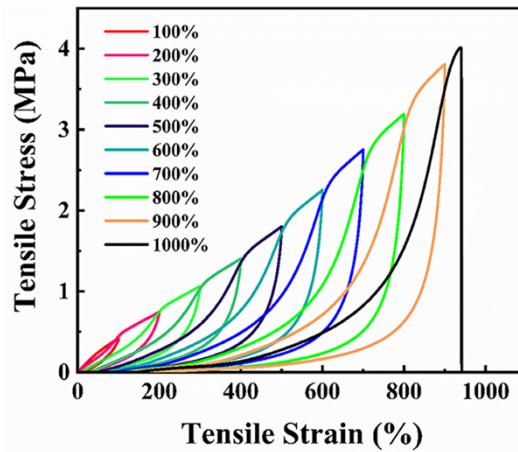


Fig. S4 The successive loading-unloading cycles of the PNH DN hydrogel.

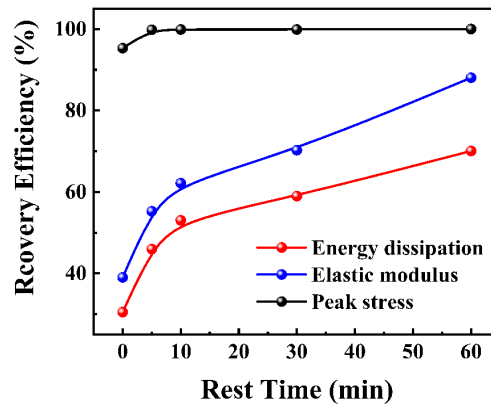


Fig. S5 Recovery efficiency of the energy dissipation, elastic modulus and peak stress of the PNH DN hydrogel with rest time of 0, 5, 10, 30 and 60 min.

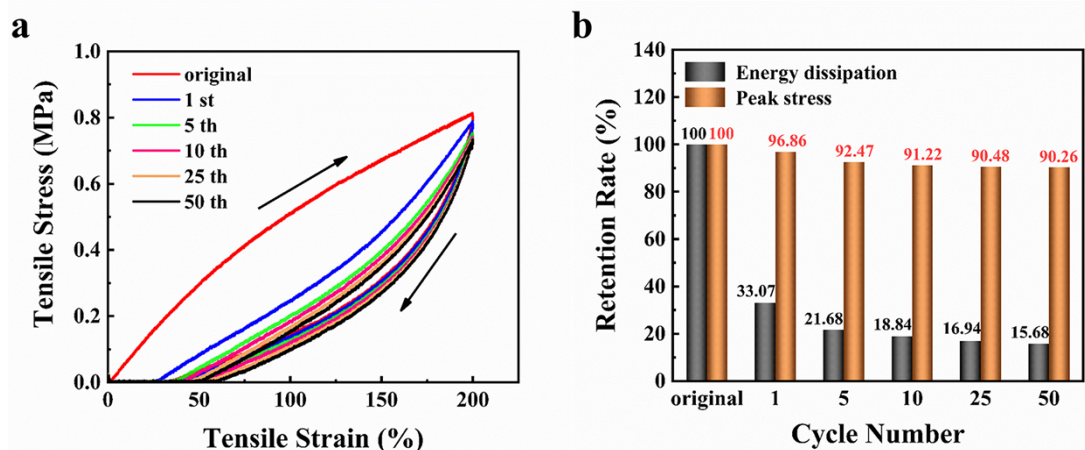


Fig. S6 (a) The anti-fatigue test and (b) retention rate of energy dissipation and peak stress of the PNH DN hydrogel.

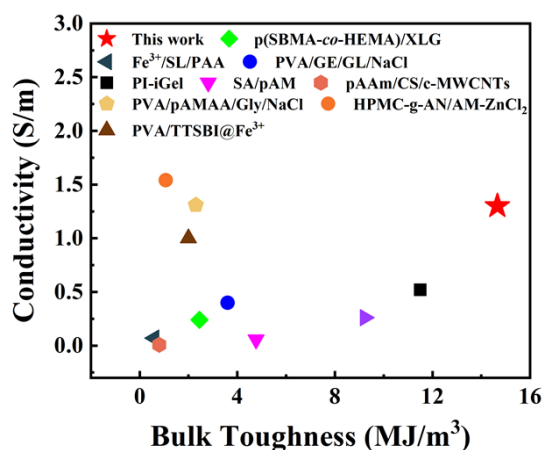


Fig. S7 A comparison of bulk toughness and conductivity among different hydrogels, including PNH DN hydrogel in this work, p(SBMA-co-HEMA)/XLG,¹ Fe³⁺/SL/PAA,² PVA/GE/GL/NaCl,³ PI-iGel,⁴ SA/pAM,⁵ pAAM/CS/c-MWCNTs,⁶ PVA/pAMAA/Gly/NaCl,⁷ HPMC-g-AN/AM-ZnCl₂,⁸ Strach/PVA/Gly/CaCl₂,⁹ and PVA/TTSBI@Fe³⁺.¹⁰

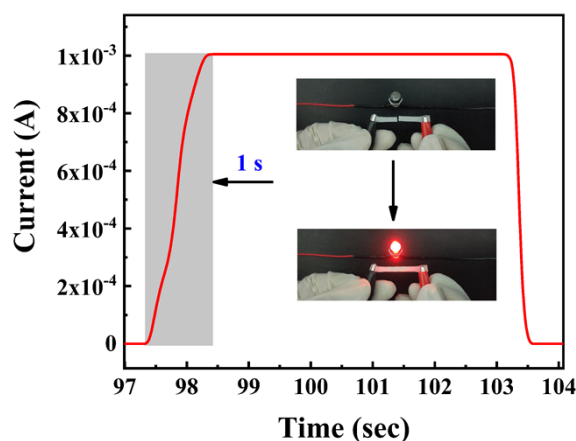


Fig. S8 The resistance recover time of the PNH DN hydrogel during self-healing without external stimulation.

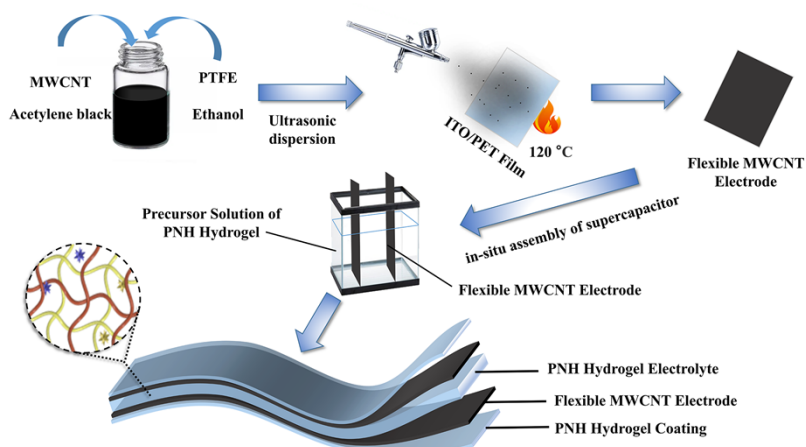


Fig. S9 Schematic diagram of preparation of flexible solid state supercapacitor based on the PNH DN hydrogel.

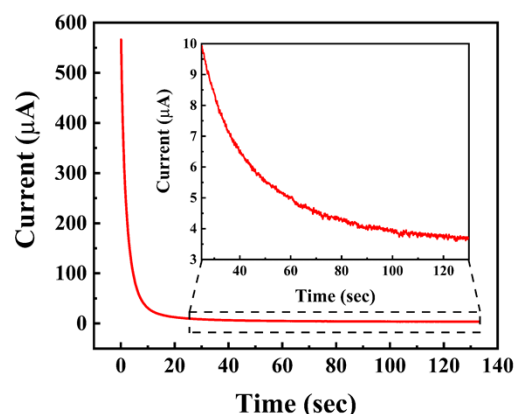


Fig. S10 Self-discharge behavior of flexible solid state supercapacitor based on the PNH DN hydrogel.

Table S1. The properties of reported conductive hydrogels for flexible strain sensors.

| Composition | Maximal strain (%) | Maximal strength (KPa) | Maximal gauge factor | Sensing ranges (%) | Anti-freezing | Ref. |
|---------------------------------|--------------------|------------------------|----------------------|--------------------|---------------|-----------|
| PVA/NaCl/pHEAA | 872 | 3760 | 1.74 | 0-735 | Yes | This work |
| PAA/PANI | 1160 | 300 | 1.05 | 0-1130 | No | 11 |
| κ -carrageenan/PAAm | 2100 | 560 | 0.63 | 0-1000 | No | 12 |
| PVA/G/PDA/AgNPs | 331 | 1174 | 0.94 | 0-315 | No | 13 |
| PVA/Gly/NaCl | 350 | 1400 | 1.56 | 0-355 | Yes | 14 |
| PAAm/PDA/KCl | 1000 | 25 | 0.7 | 0-1000 | No | 15 |
| Cellulose/NaCl | 236 | 50 | 0.29 | 0-230 | Yes | 16 |
| PAAm/Casein/LiCl | 1465 | 170 | 0.4 | 0-100 | Yes | 17 |
| PSBMA/PVA | 400 | 600 | 1.5 | 0-300 | No | 18 |
| PAA/GO/FeCl ₃ | 630 | 400 | 1.32 | 0-500 | No | 19 |
| PAAm/PSBMA/NaCl | 1150 | 600 | <1 | 0-700 | No | 20 |
| PAAm/Alginate/CaCl ₂ | 1700 | 375 | 0.3 | 20-800 | No | 21 |

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